

2011 Flash Memory Summit Presentation David Eggleston, CEO

August 10, 2011



Who we are

Company Overview

Founded: 2002

Technology: CMOx Cross-point Memory™ is a replacement for

high density NAND

Physics of Oxygen movement enables our devices

Development: 2-year JDP with Micron

Patents: IP protected by more than 108 granted patents

Our business model: •IP licensing

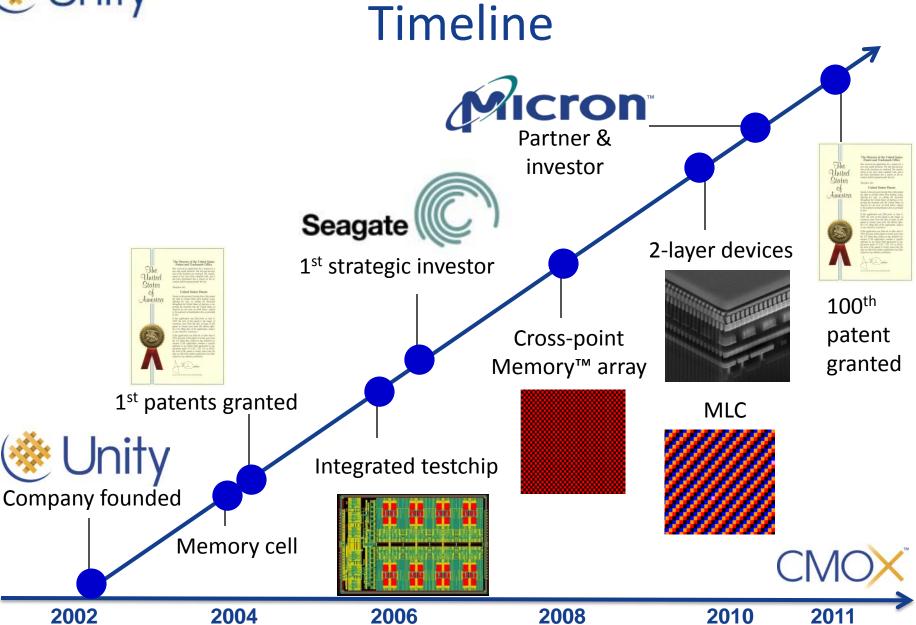
Specialty product sales

Corporate backers:



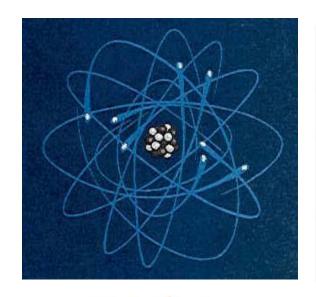








CMOx™ Memory Cell

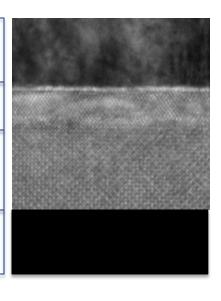


Noble metal electrode

Insulating Metal Oxide

Conductive Metal Oxide

Electrode





Moving Oxygen in and out of thin films under electric field control enables CMOx™ to scale to 10nm and beyond

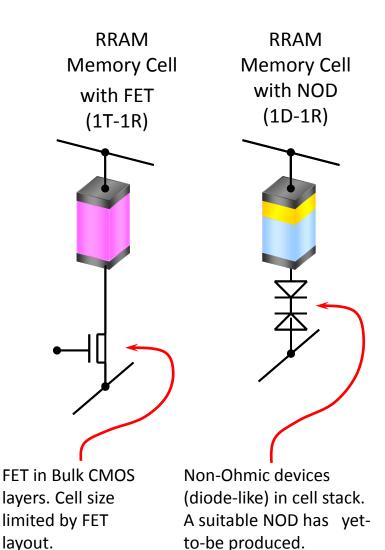
CMOx[™] uses Oxygen physics to surpass NAND.

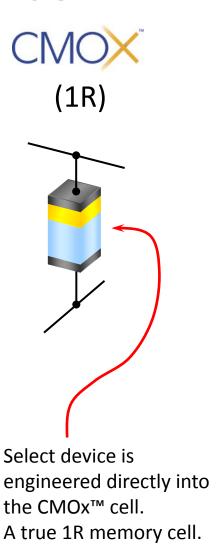


Where is the Select Device?

Two terminal memory cells are severely limited by stray currents.
Some type of select device must be used.

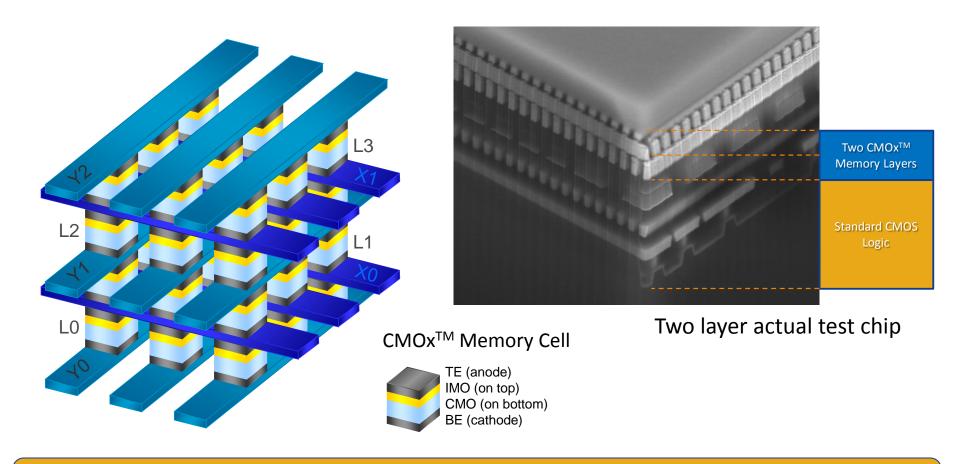
Extra select devices (1T or 1D) add complexity or cell area.







Multi-Layer CMOxTM

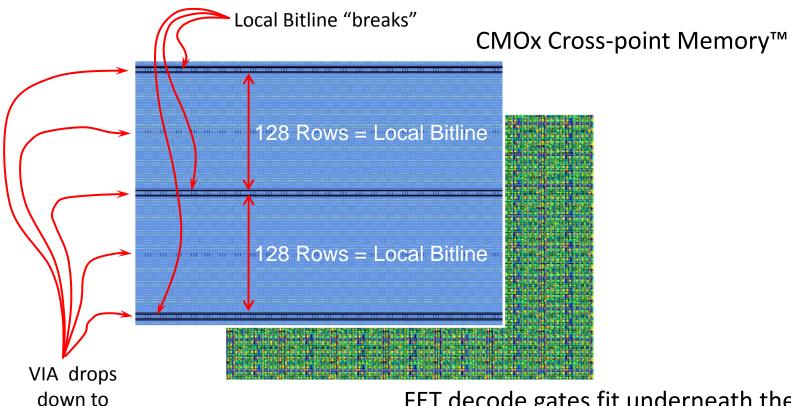


Four layers of CMOx[™] are planned for commercialization.



CMOS

CMOx™ Memory Tile

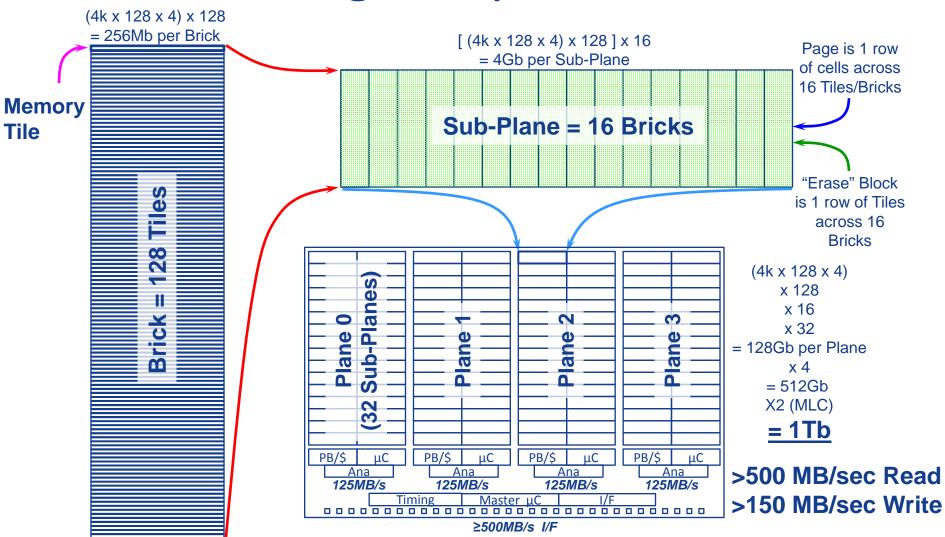


FET decode gates fit underneath the memory

Unity's patented CMOx™ Memory Tile achieves maximum array efficiency.

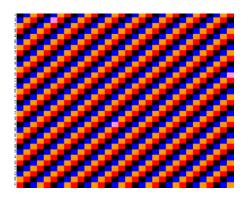


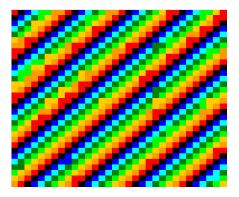
1Tb Storage Chip Architecture



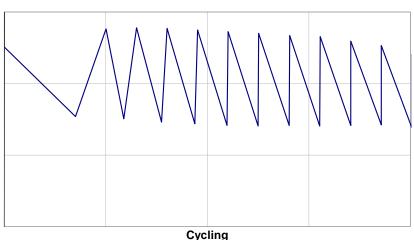


CMOx™: Demonstration





 MLC/TLC write & read achieved in a true 1R cross-point memory





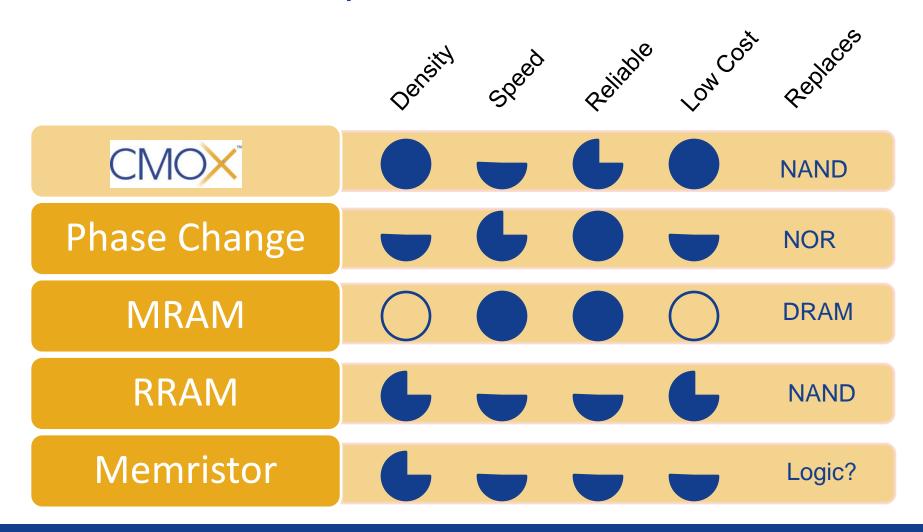
>10K write cycles
 with uniform switching

• 5 year data retention



Competitive Environment

Unity Well Positioned

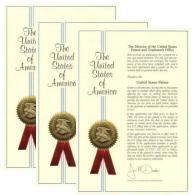




What We Offer Licensees



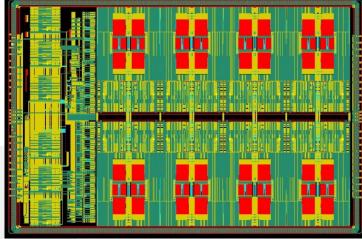
Process technology transfer



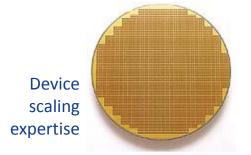
Patent license



Access to Unity Engineers



Reference design



Unity offers a comprehensive bundle of IP and engineering know-how to licensees.



Summary

- We designed, architected and patented a transistorless memory cell that we fabricate into ultra dense cross-point arrays.
- CMOx Cross-point Memory™ is engineered to replace NAND.
- Our Micron joint development program is scaling CMOx™ in a state-of-the-art 300mm fab using industry standard tools.
- CMOx Cross-point Memory[™] will come to market through our licensing and technology transfer to memory semiconductor companies and through specialty chips we sell directly.





Technology for Terabits